

*Application

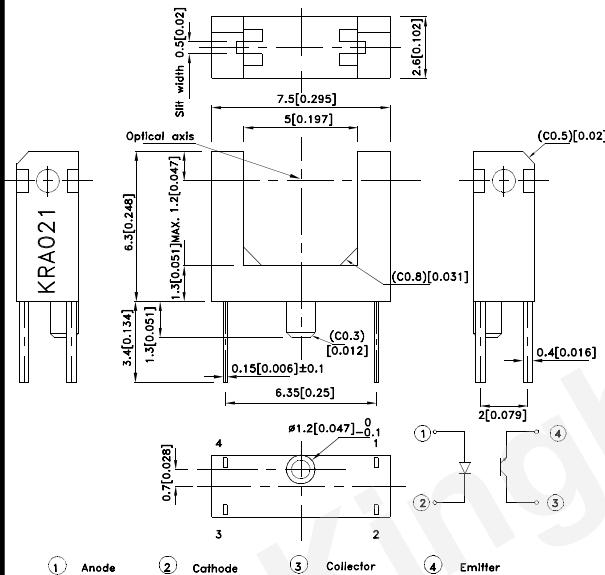
- 1.Copiers,printers and Fax Machines.
- 2.VCRs and CD players.
- 3.Various position detection sensor.

*Features

- 1.Compact package.
- 2.High sensing accuracy(Slit width:0.5mm).
- 3.Printed wiring board direct mounting type(with a locating pin).
- 4.Gap between light emitter and detector:5mm.
- 5.Compliant with European RoHS directives.
- 6.RoHS compliant.

*Dimensions

Note:All units are in millimeters unless otherwise indicated.



Unless otherwise.,the tolerances are $\pm 0.15\text{mm}$.

*Absolute Maximum Ratings ($T_a=25^\circ\text{C}$)

	Parameter	Symbol	Rating	Unit
Input	Forward current[1]	I _F	30	mA
	Reverse voltage	V _R	5	V
	Power dissipation	P _d	35	mW
	Peak Forward Current [2]	I _{FP}	100	mA
Output	Collector-emitter voltage	V _{C EO}	35	V
	Emitter-collector voltage	V _{E CO}	5	V
	Collector current	I _C	50	mA
	Collector power dissipation	P _C	75	mW
Operating temperature		T _{opr}	-30~+85	°C
Storage temperature		T _{stg}	-40~+100	°C
Soldering temperature(5s) [3]		T _{sol}	260	°C

Notes:

- 1.Refer to the temperature rating chart if the ambient temperature exceeds 25°C .
- 2.Duty:1/100,Pulse Width:0.1mS.
- 3.At the location of 1.5mm from the package bottom.

*Electrical / Optical Characteristics at $T_a=25^\circ\text{C}$

Parameter	Symbol	Value			Conditions	
		Min.	Typ.	Max.		
Input	Forward voltage	V _F	-	1.15V	1.40V	I _F =10mA
	Reverse current	I _R	-	-	10μA	V _R =5V
	Peak Wavelength	λ _p	-	940nm	-	-
Output	Collector current	I _C /I _F	2.5%	-	50%	I _F =10mA, V _{C E} =2V
	Collector dark current	I _D	-	-	100nA	V _{C E} =24V, I _F =0
	Collector-emitter saturation voltage	V _{C E(sat)}	-	0.1V	0.4V	I _C =0.25mA, I _F =20mA
	Peak spectral sensitivity wavelength	λ _p	-	920nm	-	-
Rise time	tr	-	15μsec	50μsec	V _{CC} =5V, R _L =1KΩ I _C =1mA	
Fall time	tf	-	15μsec	50μsec		



Fig.1 Forward Current vs. Forward Voltage

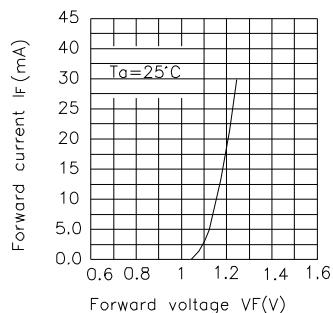


Fig.2 Collector Current vs. Forward Current

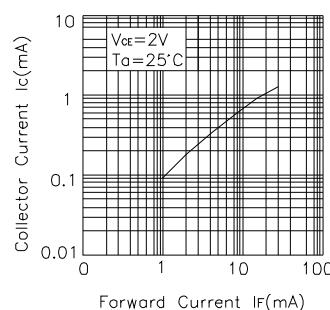


Fig.3 Collector Current vs. Ambient Temperature

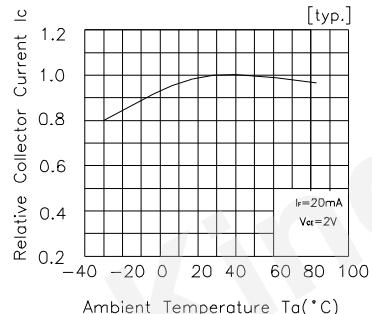


Fig.4 Collector-Emitter Saturation Voltage vs. Ambient Temperature

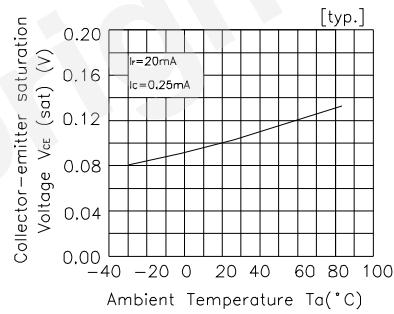


Fig.5 Forward Current vs. Collector Dissipation Temperature Rating

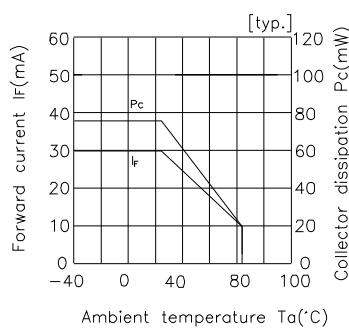


Fig.6 Forward Current vs. Collector-Emitter Voltage

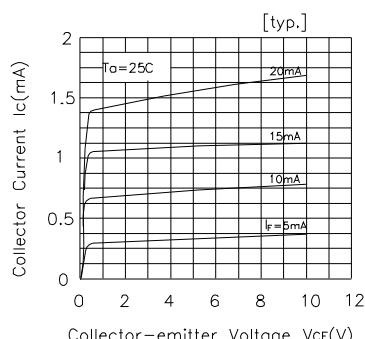


Fig.7 Relative Collector Current vs. Shield Distance(1)

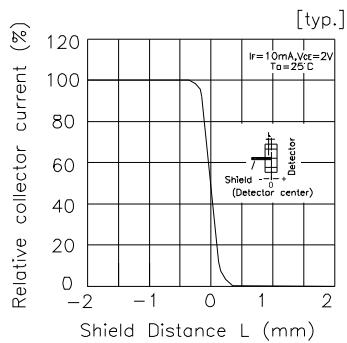


Fig.8 Relative Collector Current vs. Shield Distance(2)

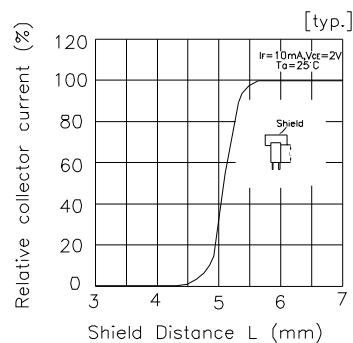
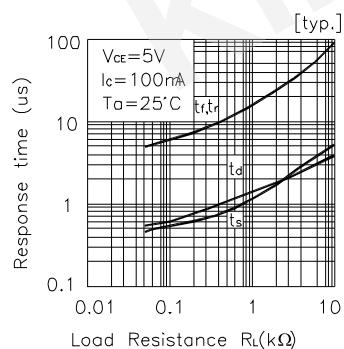
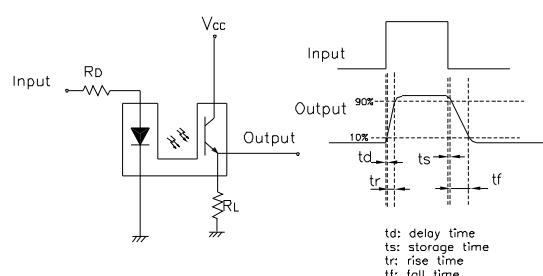


Fig.9 Response Time vs Load Resistance

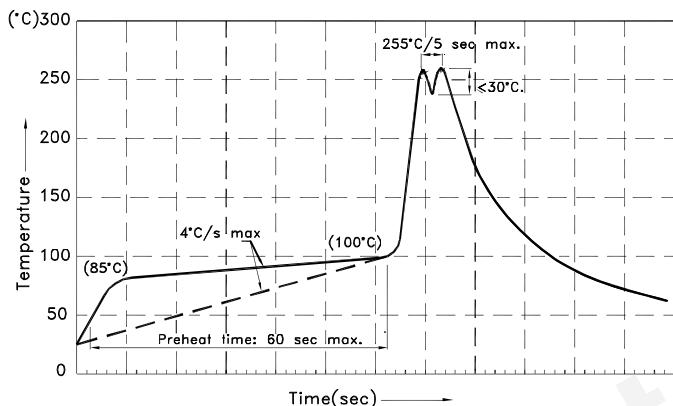


Test Circuit for Response Time



KRA021

Wave Soldering Profile For Lead-free Through-hole LED.

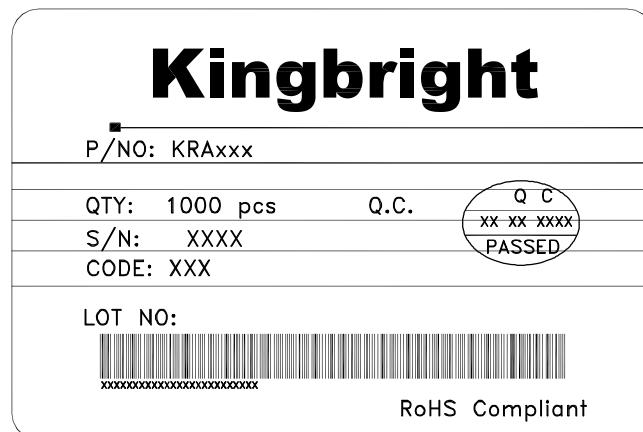
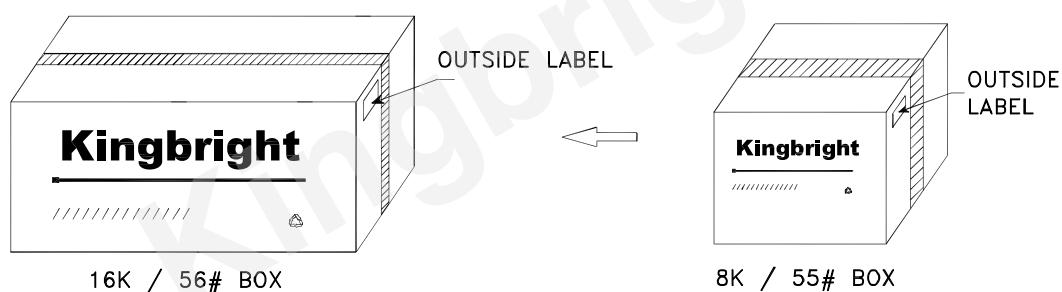
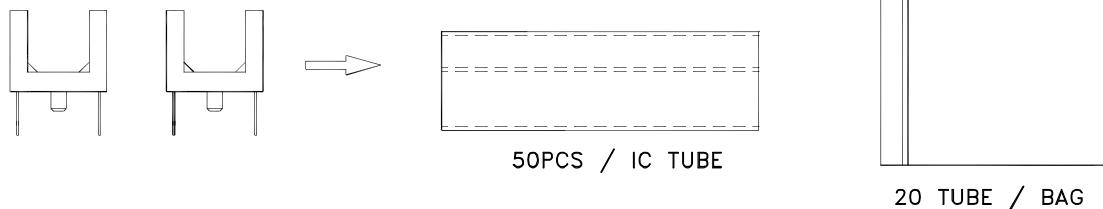


Notes:

1. Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C.
2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max).
3. Do not apply stress to the epoxy resin while the temperature is above 85°C.
4. Fixtures should not incur stress on the component when mounting and during soldering process.
5. SAC 305 solder alloy is recommended.
6. No more than one wave soldering pass.

PACKING & LABEL SPECIFICATIONS

KRA021



Detailed application notes are listed on our website.
http://www.kingbright.com/application_notes